

L Number	Hits	Search Text	DB	Time stamp
-	1	73/862.08-862.195.ccls. and (83.clas. or 225.clas. or 30.clas.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/26 10:03
-	6	((force or strain or load) near (sens\$4 or gauge or detect\$4)) near11 handle) and (83.clas. or 225.clas. or 30.clas.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/26 10:14
-	0	((force or strain or load) near (sens\$4 or gauge or detect\$4)) near11 handle) and (83.clas. or 225.clas. or 30.clas.)	USOCR	2004/10/26 10:07
-	20	("1388131" "1641153" "2556725" "2618993" "2704472" "2729995" "2737071" "2786378" "2800042" "3059511" "3272002" "3330148" "4132107" "4144737" "4158302" "4240280" "4342216" "4403531" "4581894" "4604890").PN.	USPAT	2004/10/26 10:10
-	11	((force or strain or load) near (sens\$4 or gauge or detect\$4)) and 225.clas.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/26 10:27
-	2	((force or strain or load) near (sens\$4 or gauge or detect\$4)) and 225.clas.	USOCR	2004/10/26 10:18
-	17	((force or strain or load) near (sens\$4 or gauge or detect\$4 or measur\$4)) and 225.clas.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/26 10:31
-	309	(force or strain or load) and 225/96.5.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/26 10:30
-	14	((force or strain or load) near11 (sens\$4 or gauge or detect\$4 or measur\$4)) and 225/96.5.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/26 10:51
-	4	((force or strain or load) near11 (sens\$4 or gauge or detect\$4 or measur\$4)) and 225/96.5.ccls.	USOCR	2004/10/26 11:02
-	4	("2534756").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/26 10:39
-	1	2534756.URPN.	USPAT	2004/10/26 10:39
-	16	(("0140426") or ("0419018") or ("0494921") or ("1344533") or ("1344562") or ("1656104")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/26 10:45
-	106	225/96.5.ccls. and handle	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/26 13:33
-	41	((force or strain or load) near11 (sens\$4 or gauge or detect\$4 or measur\$4)) and 438/460-465.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/26 10:54
-	114	glass and 225/96.5.ccls.	USOCR	2004/10/26 11:10

-	570	(225/96.5).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USOCR	2004/10/26 11:10
-	52	225/96.5.ccls. and semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USOCR	2004/10/26 13:45
-	6	225/96.5.ccls. and semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USOCR	2004/10/26 13:40
-	0	81/467, 479	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USOCR	2004/10/26 13:45
-	386	(81/467, 479).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/10/26 13:45